# MSB1218A-RT1G

# PNP Silicon General Purpose Amplifier Transistor

This PNP Silicon Epitaxial Planar Transistor is designed for general purpose amplifier applications. This device is housed in the SC-70/SOT-323 package which is designed for low power surface mount applications.

#### Features

- High h<sub>FE</sub>, 210 460
- Low V<sub>CE(sat)</sub>, < 0.5 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS** ( $T_A = 25^{\circ}C$ )

Rating	Symbol	Value	Unit
Collector-Base Voltage	V <sub>(BR)CBO</sub>	45	Vdc
Collector-Emitter Voltage	V <sub>(BR)CEO</sub>	45	Vdc
Emitter-Base Voltage	V <sub>(BR)EBO</sub>	7.0	Vdc
Collector Current - Continuous	۱ <sub>C</sub>	100	mAdc
Collector Current - Peak	I <sub>C(P)</sub>	200	mAdc

#### THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Power Dissipation (Note 1)	PD	150	mW
Junction Temperature	TJ	150	°C
Storage Temperature Range	T <sub>stg</sub>	- 55 to +150	°C

### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Max	Unit
Collector-Emitter Breakdown Voltage ( $I_{C}$ = 2.0 mAdc, $I_{B}$ = 0)	V <sub>(BR)CEO</sub>	45	-	Vdc
Collector-Base Breakdown Voltage (I <sub>C</sub> = 10 $\mu$ Adc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	45	-	Vdc
Emitter-Base Breakdown Voltage (I <sub>E</sub> = 10 $\mu$ Adc, I <sub>E</sub> = 0)	V <sub>(BR)EBO</sub>	7.0	-	Vdc
Collector-Base Cutoff Current ( $V_{CB}$ = 20 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	-	0.1	μA
Collector-Emitter Cutoff Current ( $V_{CE}$ = 10 Vdc, $I_B$ = 0)	I <sub>CEO</sub>	-	100	μA
DC Current Gain (Note 2) $(V_{CE} = 10 \text{ Vdc}, I_C = 2.0 \text{ mAdc})$	h <sub>FE1</sub>	210	340	-
Collector-Emitter Saturation Voltage (Note 2) ( $I_C$ = 100 mAdc, $I_B$ = 10 mAdc)	V <sub>CE(sat)</sub>	-	0.5	Vdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Device mounted on a FR-4 glass epoxy printed circuit board using the minimum recommended footprint.

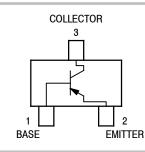
2. Pulse Test: Pulse Width  $\leq$  300 µs, D.C.  $\leq$  2%.

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SC-70 (SOT-323) CASE 419 STYLE 4

### MARKING DIAGRAM



BR = Device Code

M = Date Code\*

= Pb-Free Package

(Note: Microdot may be in either location) \*Date Code orientation may vary depending upon manufacturing location.

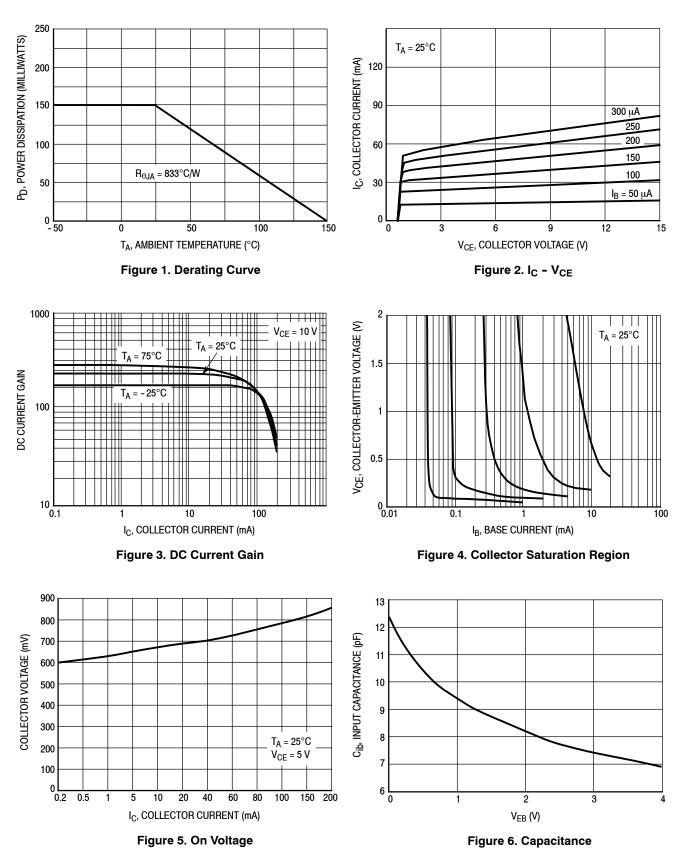
#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MSB1218A-RT1G	SC-70 (Pb-Free)	3000 /Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

October, 2010 - Rev. 7

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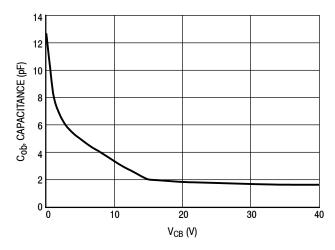
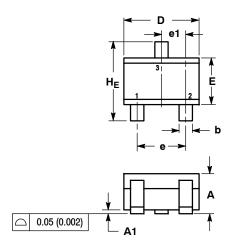


Figure 7. Capacitance

#### PACKAGE DIMENSIONS

SC-70 (SOT-323) CASE 419-04 **ISSUE N** 

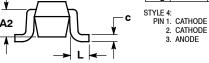


Α2

NOTES: DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

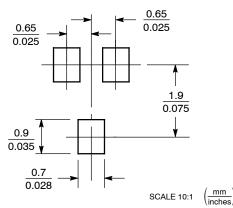
2 CONTROLLING DIMENSION: INCH.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.70 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
Е	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095



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#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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